NSN 5961-01-365-5033

Unitized Semiconductor Devices - Page 1 of 1



View Online at https://aerobasegroup.com/nsn/5961-01-365-5033 **Inclosure Material:** Metal **Overall Length:** 0.820 inches **Overall Height:** 0.275 inches **Overall Width:** 0.690 inches **Mounting Facility Quantity: Component Name And Quantity:** 1 semiconductor device diode and 1 transistor **Mounting Method:** Unthreaded hole **Features Provided:** Electrostatic sensitive and hermetically sealed case **Semiconductor Material:** Silicon single transistor Voltage Rating In Volts Per Characteristic: 500.0 drain to source voltage single transistor **Current Rating Per Characteristic:** 4.50 amperes forward current, dc single semiconductor device diode **Maximum Operating Tempurature Per Measurement Point:** 80.0 degrees celsius ambient air **Special Features:** Single semiconductor device diode junction pattern arrangement: pn **Terminal Type And Quantity:** 5 uninsulated wire lead Shelf Life: N/a **Unit Of Measure: Demilitarization:** No

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